

General Description

FSMOS® MOSFET is based on Oriental Semiconductor's unique device design to achieve low $R_{DS(ON)}$, low gate charge, fast switching and excellent avalanche characteristics. The high V_{th} series is specially designed to use in motor control systems with driving voltage of more than 10V.

Features

- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent reliability and uniformity
- Fast switching and soft recovery



Applications

- PD charger
- Motor driver
- Switching voltage regulator
- DC-DC convertor
- Switching mode power supply

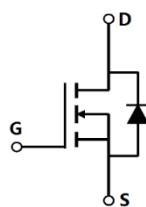
Key Performance Parameters

| Parameter | Value | Unit |
|-----------------------------------|-------|------|
| V_{DS} | 80 | V |
| I_D , pulse | 1600 | A |
| $R_{DS(ON)}$, max @ $V_{GS}=10V$ | 1.3 | mΩ |
| Q_g | 166 | nC |

Marking Information

| Product Name | Package | Marking |
|---------------|----------|--------------|
| SFS08R013K7NF | TO263-6L | SFS08R013K7N |

Package & Pin information



Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

| Parameter | Symbol | Value | Unit |
|---|-----------------------|------------|------------------|
| Drain-source voltage | V_{DS} | 80 | V |
| Gate-source voltage | V_{GS} | ± 20 | V |
| Continuous drain current ¹⁾ , $T_C=25^\circ\text{C}$ | I_D | 400 | A |
| Pulsed drain current ²⁾ , $T_C=25^\circ\text{C}$ | $I_{D, \text{pulse}}$ | 1600 | A |
| Continuous diode forward current ¹⁾ , $T_C=25^\circ\text{C}$ | I_S | 400 | A |
| Diode pulsed current ²⁾ , $T_C=25^\circ\text{C}$ | $I_{S, \text{pulse}}$ | 1600 | A |
| Power dissipation ³⁾ , $T_C=25^\circ\text{C}$ | P_D | 550 | W |
| Single pulsed avalanche energy ⁵⁾ | E_{AS} | 735 | mJ |
| Operation and storage temperature | T_{stg}, T_j | -55 to 175 | $^\circ\text{C}$ |

Thermal Characteristics

| Parameter | Symbol | Value | Unit |
|--|-----------------|-------|---------------------------|
| Thermal resistance, junction-case | $R_{\theta JC}$ | 0.27 | $^\circ\text{C}/\text{W}$ |
| Thermal resistance, junction-ambient ⁴⁾ | $R_{\theta JA}$ | 62 | $^\circ\text{C}/\text{W}$ |

Electrical Characteristics at $T_j=25^\circ\text{C}$ unless otherwise specified

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|----------------------------------|---------------------|------|------|------|------------------|---|
| Drain-source breakdown voltage | BV_{DSS} | 80 | | | V | $V_{GS}=0 \text{ V}, I_D=250 \mu\text{A}$ |
| Gate threshold voltage | $V_{GS(\text{th})}$ | 2 | | 4 | V | $V_{DS}=V_{GS}, I_D=250 \mu\text{A}$ |
| Drain-source on-state resistance | $R_{DS(\text{ON})}$ | | 0.9 | 1.3 | $\text{m}\Omega$ | $V_{GS}=10 \text{ V}, I_D=50 \text{ A}$ |
| Gate-source leakage current | I_{GSS} | | | 100 | nA | $V_{GS}=20 \text{ V}$ |
| | | | | -100 | | $V_{GS}=-20 \text{ V}$ |
| Drain-source leakage current | I_{DSS} | | | 1 | μA | $V_{DS}=80 \text{ V}, V_{GS}=0 \text{ V}$ |
| Gate resistance | R_G | | 1.5 | | Ω | $f=1 \text{ MHz}, \text{Open drain}$ |

Dynamic Characteristics

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|------------------------------|---------------------|------|-------|------|------|--|
| Input capacitance | C _{iss} | | 10500 | | pF | V _{GS} =0 V, V _{DS} =25 V, f=100 kHz |
| Output capacitance | C _{oss} | | 5870 | | pF | |
| Reverse transfer capacitance | C _{rss} | | 459 | | pF | |
| Turn-on delay time | t _{d(on)} | | 26 | | ns | V _{GS} =10 V, V _{DS} =40 V, R _G =2 Ω, I _D =40 A |
| Rise time | t _r | | 25 | | ns | |
| Turn-off delay time | t _{d(off)} | | 70 | | ns | |
| Fall time | t _f | | 37 | | ns | |
| | | | | | | |

Gate Charge Characteristics

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|----------------------|----------------------|------|------|------|------|--|
| Total gate charge | Q _g | | 166 | | nC | V _{GS} =10 V, V _{DS} =40 V, I _D =40 A |
| Gate-source charge | Q _{gs} | | 39 | | nC | |
| Gate-drain charge | Q _{gd} | | 42 | | nC | |
| Gate plateau voltage | V _{plateau} | | 4.1 | | V | |

Body Diode Characteristics

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|-------------------------------|------------------|------|------|------|------|--|
| Diode forward voltage | V _{SD} | | | 1.3 | V | I _s =30 A, V _{GS} =0 V |
| Reverse recovery time | t _{rr} | | 112 | | ns | V _R =40 V, I _s =40 A, di/dt=100 A/μs |
| Reverse recovery charge | Q _{rr} | | 205 | | nC | |
| Peak reverse recovery current | I _{rrm} | | 3.6 | | A | |

Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) Pd is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_a=25 °C.
- 5) V_{DD}=50V, V_{GS}=10 V, L=0.3 mH, starting T_j=25 °C.

Electrical Characteristics Diagrams

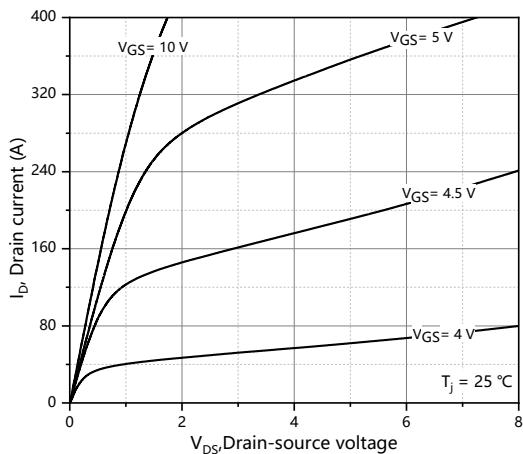


Figure 1. Typ. output characteristics

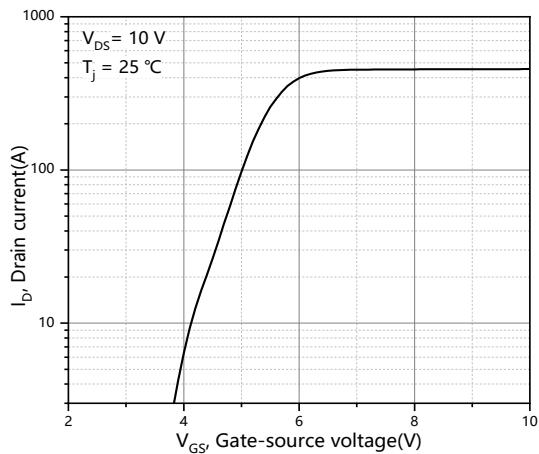


Figure 2. Typ. transfer characteristics

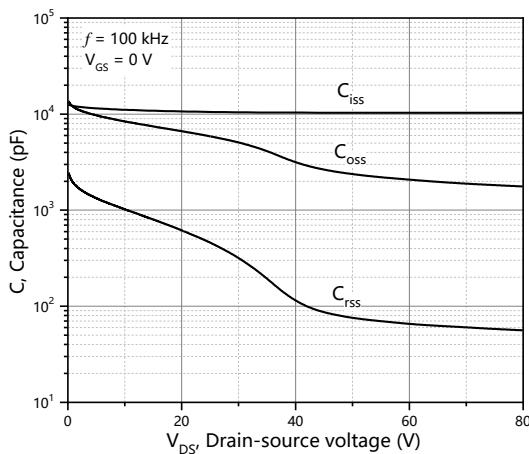


Figure 3. Typ. capacitances

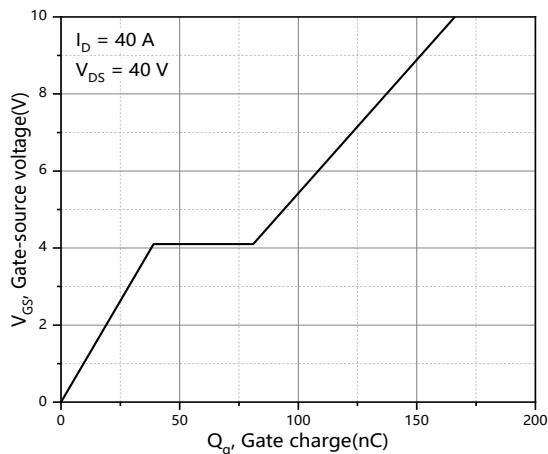


Figure 4. Typ. gate charge

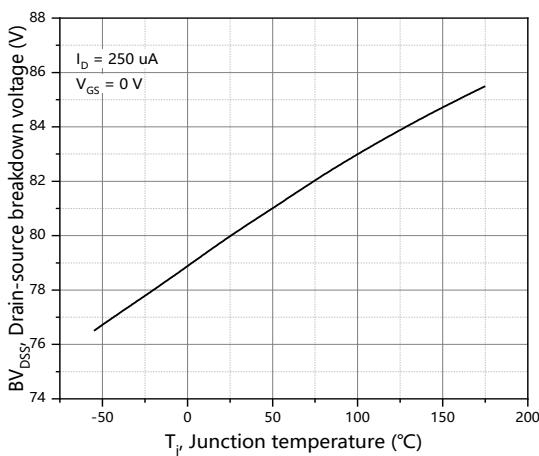


Figure 5. Drain-source breakdown voltage

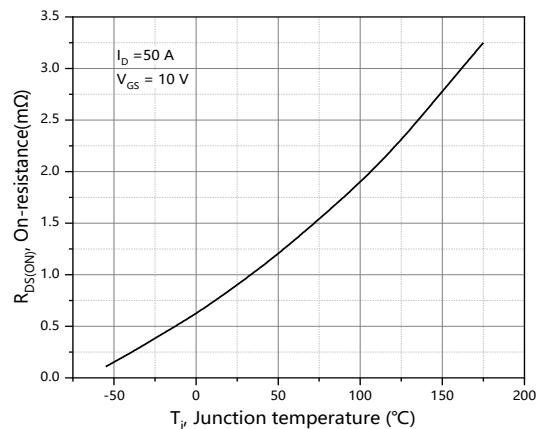
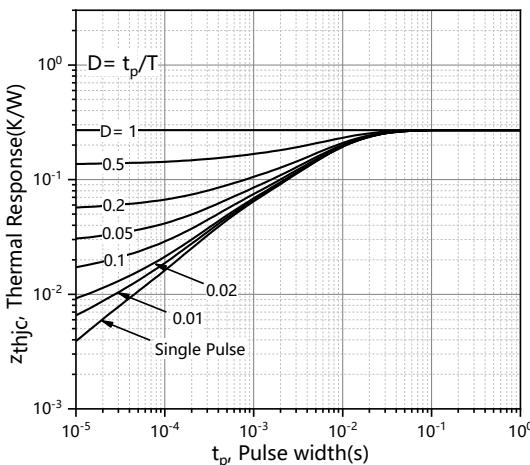
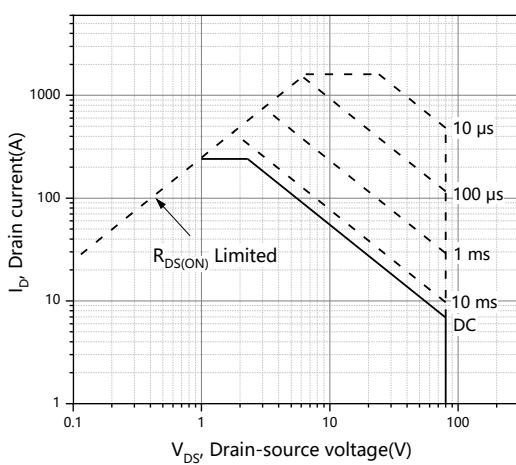
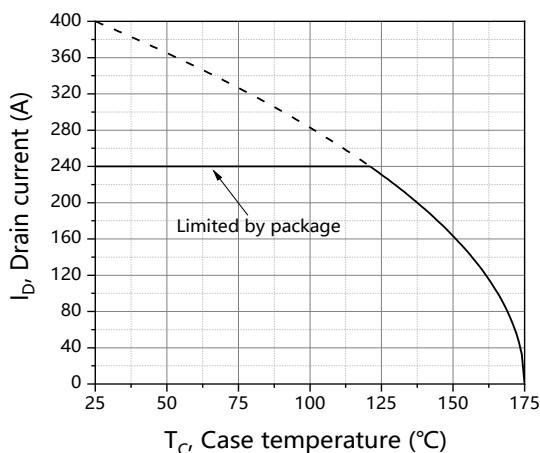
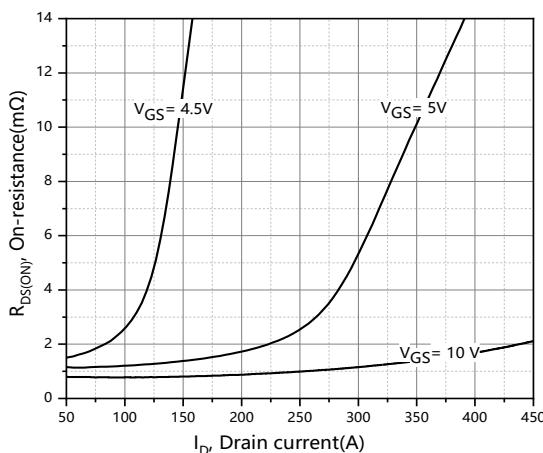
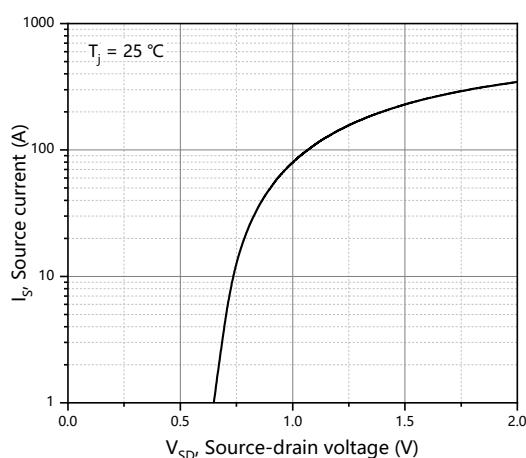
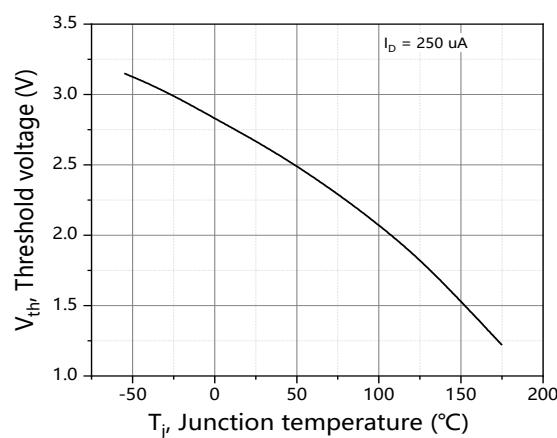


Figure 6. Drain-source on-state resistance



Test circuits and waveforms

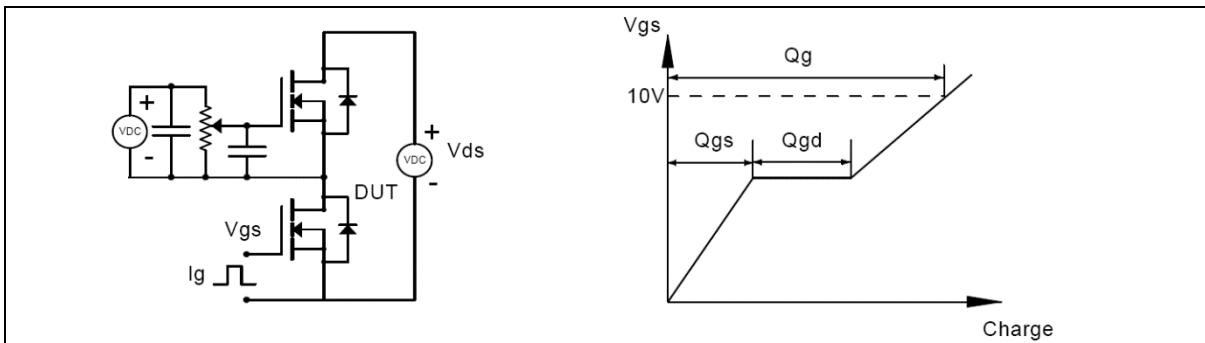


Figure 1. Gate charge test circuit & waveform

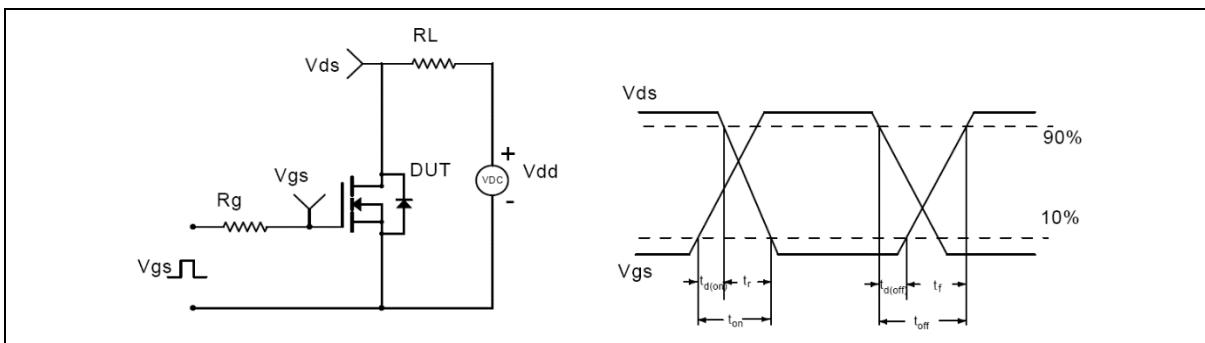


Figure 2. Switching time test circuit & waveforms

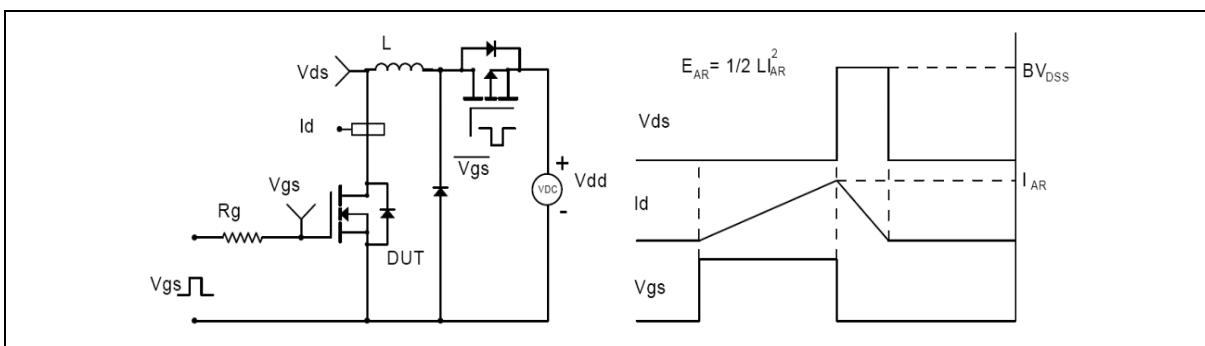


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms

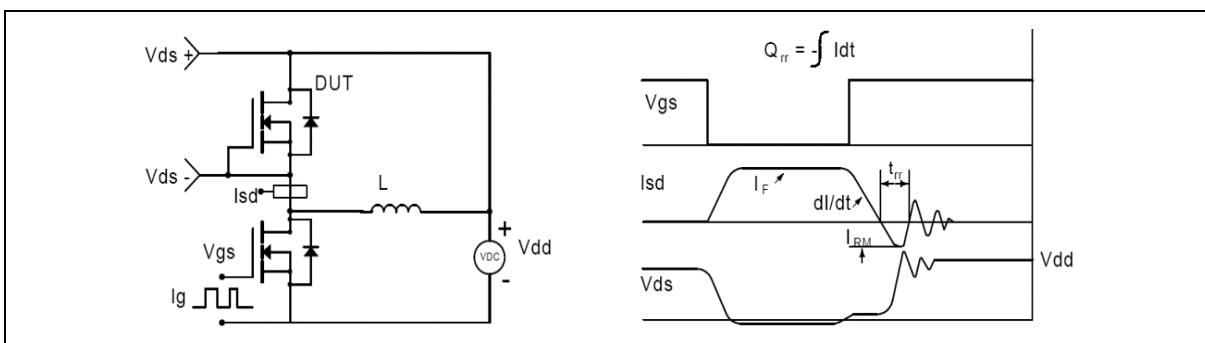
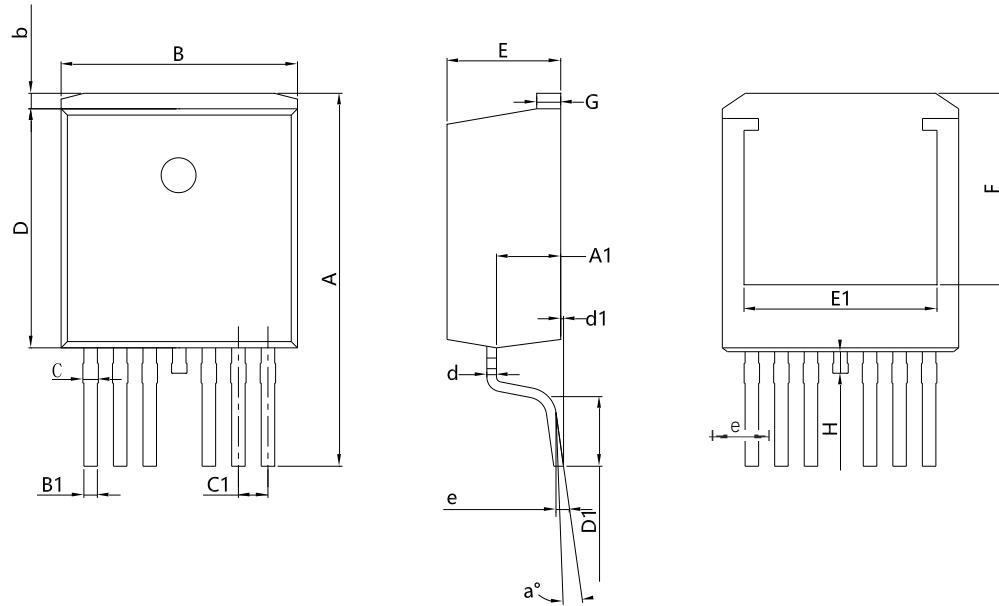


Figure 4. Diode reverse recovery test circuit & waveforms

Package Information



| Symbol | mm | | |
|--------|----------|-------|-------|
| | Min | Nom | Max |
| A | 14.65 | 15.00 | 15.35 |
| A1 | 2.25 | 2.40 | 2.55 |
| B | 9.80 | 10.00 | 10.20 |
| B1 | 0.50 | 0.60 | 0.70 |
| b | 0.80 | 1.00 | 1.20 |
| C | 0.58 | 0.68 | 0.84 |
| C1 | 1.27 BSC | | |
| D | 9.05 | 9.25 | 9.45 |
| D1 | 2.40 | 2.70 | 3.00 |
| d | 0.40 | 0.50 | 0.60 |
| d1 | 0.01 | 0.13 | 0.25 |
| E | 4.25 | 4.40 | 4.55 |
| E1 | 7.25 | - | - |
| F | 6.90 | - | - |
| e | 0.25 BSC | | |
| G | 1.20 | 1.30 | 1.40 |
| a | 2° | 5° | 8° |
| H | 0.85 | 1.00 | 1.15 |

Version 1: TO263-6L-P package outline dimension

Ordering Information

| Package Type | Units/Reel | Reels / Inner Box | Units/Inner Box | Inner Boxes/Carton Box | Units/Carton Box |
|--------------|------------|-------------------|-----------------|------------------------|------------------|
| TO263-6L-P | 800 | 1 | 800 | 5 | 4000 |

Product Information

| Product | Package | Pb Free | RoHS | Halogen Free |
|---------------|----------|---------|------|--------------|
| SFS08R013K7NF | TO263-6L | yes | yes | yes |

Legal Disclaimer

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